PRODUCT / PROCESS CHANGE INFORMATION

1. PCI basic data	
1.1 Company	STMicroelectronics International N.V
1.2 PCI No.	ANALOG MEMS SENSORS/26/16183
1.3 Title of PCI	Henkel PFAS Free 8601S25NP Qualification
1.4 Product Category	See product list
1.5 Issue date	2026-10-28

2. PCI Team	
2.1 Contact supplier	
2.1.1 Name	PIKE EMMA
2.1.2 Phone	+44 1628896111
2.1.3 Email	emma.pike@st.com
2.2 Change responsibility	
2.2.1 Product Manager	Marcello SAN BIAGIO
2.1.2 Marketing Manager	Francesco MACINA,Elena Maria PERNIGOTTI,Max Brambilla
2.1.3 Quality Manager	Jean-Marc BUGNARD

3. Change		
3.1 Category	3.2 Type of change	3.3 Manufacturing Location
Materials	Direct Material: Die Attach Material - Chemistry/ Raw material	ST SHENZHEN (CHINA)

4. Description of change		
	Old	New
4.1 Description	PFAS Contained material (Anti bleeding Agent) GLUE LOCTITE ABLESTIK 8601S-25	PFAS Free Material GLUE LOCTITEABLESTIK ABP8601S25NP
4.2 Anticipated Impact on form,fit, function, quality, reliability or processability?	No impact	

5. Reason / motivation for change	
5.1 Motivation	To be EHS compliant
5.2 Customer Benefit	ENVIRONMENT FOOTPRINT

6. Marking of parts / traceability of change	
6.1 Description	Internal traceability

7. Timing / schedule	
7.1 Date of qualification results	2026-10-22
7.2 Intended start of delivery	2026-11-27
7.3 Qualification sample available?	Not Applicable

8. Qualification / Validation			
8.1 Description	16183 PCI 16183_RER_Henkel PFAS Free 8601S25NP.pdf		
8.2 Qualification report and qualification results	Available (see attachment)	Issue Date	2026-10-28

9. Attachments (additional documentations)
16183 Public product.pdf 16183 PCI 16183_RER_Henkel PFAS Free 8601S25NP.pdf

10. Affected parts		
10. 1 Current		10.2 New (if applicable)
10.1.1 Customer Part No	10.1.2 Supplier Part No	10.1.2 Supplier Part No
	HCF4021YM013TR	
	L6390DTR	
	L6599ADTR	
	L6599ATDTR	
	A6387DTR	
	TD310IDT	

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